



SPECIFICATION FOR APPROVAL

CUSTOMER:	
CUSTOMER P/N:	
CND-TEK P/N. :	CND-DCM1206M600-2
DESCRIPTION:	Wire Wound Type Common Mode Filter
REF NO:	QTC-002
REV/NO:	A/0
DATE:	2018/06/18
ATTACHMENT:	
SPECIFICATION	

SAMPLE Q'TY OF SAMPLES

PCS

	\checkmark	CUSTOMER'S SIGNATURE	REMARK
FULL APPROVED			
CONDITIONAL APPROVED			
REJECTED			



CND-DCM1206M600-2

Wire Wound Type Common Mode Filter



V1.0.3 AUG16,2018

深圳磁联达电子有限公司

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变更履历表

变更日期	变更内容	版次	备注
2018-8-16	新制作	A0	

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1. FEATURES:

- 1.1 High common mode impedance at high frequency effects excellent noise suppression performance.
- 1.2 CND-DCM1206M600-2 Series realizes small size and low profile. 3.2x1.6X2.0 mm.
- 1.3 100% Lead(Pb) & Halogen-Free and RoHS compliant.
- 1.4 Operating Temperature range: -40~+125°C (Including self temperature rise)
- 1.5 Storage temperature range: $-40 \sim +125$ °C (on board)

2.ELECTRICAL SPECIFICATIONS @25°C

- 2.1 Inductance(µ H) [100kHz/0.1V] Min : 60
- 2.2 Test Frequency (MHz) :100
- 2.3 DCResistance (Ω) max: 1.70
- 2.4 Rated Current (mA)max: 200
- 2.5 Rated Volt.(Vdc)max: 50
- 2.6 Withstand Volt. (Vdc) max:125
- 2.7 IR (Ω) min: 10M

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5. Typical Impedance v.s. Frequency Curve:



6. Materials:

No.	Description	Specification
a.	Upper Plate	Ferrite
b.	Core	Ferrite Core
с	Termination	Tin (Pb Free)
d	Wire	Enameled Copper Wire



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ltem	Performance			Test Con	dition
Operating temperature	-40~+125 °C (Includir	ng self -			
	temperature rise)				
Storage temperature	-40~+125°C (on board)				
Electrical Performance	Test				
Z(common mode)	Refer to standard	electrical	Agilent-4	291A+ Agilent -16197A	N N
DCR	characteristics list.		Agilent-4	338B	
I.R.			Agilent43	39	
Temperature Rise Test	Rated Current < 1A \triangle T 2	20°CMax	1.Applied	the allowed DC currer	nt.
	Rated Current \geq 1A \triangle T	40°C Max	2.Temper	ature measured by dig	ital surface thermometer
Reliability Test					
Life Test			times.(IF J-STD-02 Temperat Applied of Duration:	tioning: Run through IF PC/JEDEC 20DClassification Reflo cure: 125±2°C urrent: rated current 1000±12hrs d at room temperature	
Load Humidity			Precondi times.(IF J-STD-02 Humidity Temperat Duration	tioning: Run through IF PC/JEDEC 20DClassification Reflo : 85±2 % R.H, ture: 85°C±2°C : 1000hrs Min. with 10	R reflow for 2 w Profiles
Moisture Resistance	Appearance : No damage. Inductance : within±10% of initial value Impedance : within±15% of initial value RDC :within ±15% of initial value and shall not exceed the specification value		times.(IF J-STD-02 1. Baked after plac 2. Raise keep 3 ho 2.5hrs,ke 4. Keep a frequency room tem	ing for 4 hrs. temperature to $65\pm2^{\circ}$ C burs, cool down to 25° C temperature to $65\pm2^{\circ}$ C burs, cool down to 25° C ep at 25^{\circ}C for 2 hrs the at 25^{\circ}C 80-100%RH for y of 10 to 55 Hz to 10 h pperature after placing	w Profiles sured at room temperature 90-100%RH in 2.5hrs, and in 2.5hrs. 90-100%RH in 2.5hrs, and in en keep at -10°C for 3 hrs 15min and vibrate at the Hz, measure at for 1~2 hrs.
Thermal shock			times.(IF Reflow P Step1: Step2: 2 Step3: 1 Number of	tioning: Run through IF PC/JEDECJ-STD-020D rofiles Condition for 1 $40\pm2^{\circ}C$ 30 ± 5 min $25\pm2^{\circ}C \leq 0.5$ min $25\pm2^{\circ}C$ 30 ± 5 min of cycles: 500 d at room temperature	Classification
Vibration			Oscillatio Equipme Total Am	n Frequency: 10~2K~ nt: Vibration checker blitude:1.52mm±10% ime : 12 hours(20 minu	~10Hz for 20 minutes
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Iten	ו		Performance			Test Condit	ion	
				Туре	Peak	Normal	Wave	Velocity
					value (g ' s)	duration (D) (ms)	form	change (Vi)ft/sec
		Appea	rance: No damage.	SMD	50	11	Half-si	11.3
hock		Inducta	ance: within±10% of				ne	
		initial v	alue	Lead	50	11	Half-si	11.3
			ance : within±15% of		in eesk	diversion of	ne ne	
		initial v		axes.	n each	direction ald	ng s per	pendicula
			within ±15% of initial		mounte	d on a FR4 s	ubstrate	of the
			and shall not	-		ions: >=080	5:40x100	(1.2mm
				<0805:4).8mm		
Bending		exceed	I the specification value	Bending	-	2mm):1.2mn	•	
					•	2mm):0.8mm		
				duration	•			
				Preheat	,			
		More t	han 95% of the terminal			6 Ag3% Cu0.	5%	
Soderability		electro	de should	Temperature: 245±5°C。				
		be cov	ered with solder。	Flux for lead free: Rosin. 9.5%。 Dip time: 4±1sec。				
				Depth: completely cover the termination			'n	
				Number o		•		
Resistance				Temper	ature	Time(s)		erature
				(°C)				/immersion
o Soldering							and rate	emersion
leat				260 ±5(s	older	10 ±1	25mr	n/s ±6
				temp)			mm/s	
Ferminal Strength		Inducta initial v Impeda initial v RDC : value a	ance:within±15% of	times.(I Reflow F With the device to tested, a inch(201 inch(201 of a devi This forc Also the shall be	PC/JED Profiles compor b be upply a for 2mm):1 2mm):1 2mm):0 (ce being ce shall l force applied upply a sh	Run through EC J-STD-02 ment mounted brce (>0805 kg , <=0805 .5kg)to the s g tested. be applied fo gradually as lock to the co	20DClassi d on a PC ide r 60 +1 se	fication B with the econds. being
REPORT BY:	Y: CHECKED BY:		APPROVED BY:	CUSTO	CUSTOMER:			
zouwenqiang	Liyonghua		wangshengli	PART N	0. : CN	D-DCM120	6M600-2	
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CND-Ti		肝オ大日	电子有限公司					

8. Soldering and Mounting:8.1 Recommended PC Board Pattern

<u></u>				
L(mm)	3.70			
H(mm)	1.70			
G1(mm)	2.30			
G2(mm)	0.50			



PC board should be designed so that products can prevent damage from mechanical stress when warping the board. Products shall be positioned in the sideway direction to against the mechanical stress to prevent failure.

8.2 Soldering

Mildly activated rosin fluxes are preferred. CND-TEK terminations are suitable for all wave and re-flow soldering systems.

If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-2.1 Lead Free Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

8-2.2 Soldering Iron(Figure 2):

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that

a soldering iron must be employed the following precautions are recommended.

Preheat circuit and products to 150° C ·Never contact the ceramic with the iron tip ·Use a 20 watt soldering iron

with tip diameter of 1.0mm

355 tip temperature (max) 1.0mm tip diameter (max) Limit soldering time to 4~5 sec.



9、Packaging Information:

9.1 Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	9.0±0.5	60±2	13.5±0.5	178±2

9.2 Tape Dimension / 8mm



Serie	es	P(mm)	Po(mm)	P2(mm)	Bo(mm)	Ao(mm)	Ko(mm)	W(mm)	t(mm)
CND-DCM1206	M600-2	4.00±0.10	4.00±0.10	2.00±0.05	3.50±0.10	1.88±0.10	2.20±0.10	8.00±0.10	0.26±0.05

9.3 Packaging Quantity

Chip size	Chip/Reel	Inner Box	Middle Box	Carton
CND-DCM1206M600-2	2000	10000	50000	100000

9.4 Tearing Off Force

Top cover tape

Base tape

165 to180

The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed
(°C)	(%)	(hPa)	mm/min
5~35	45~85	860~1060	300

Application

Storage Conditions (component level)

- To maintain the solderability of terminal electrodes:
- 1. CND-TEK products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 2. Temperature and humidity conditions: Less than 40 $^\circ\!{\rm C}$ and 60% RH.
- 3. Remmended products should be used within 12 months form the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation

1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.

- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- $\ensuremath{\mathsf{3.Bulk}}$ handling should ensure that abrasion and mechanical shock are minimized.

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